### **NCE N-Channel Super Trench Power MOSFET**

#### **Description**

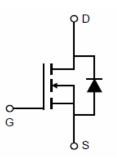
The NCEP40T15GU uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of  $R_{DS(ON)}$  and  $Q_g$ . This device is ideal for high-frequency switching and synchronous rectification.

#### **General Features**

- $V_{DS}$  =40V, $I_{D}$  =150A  $R_{DS(ON)}$ =1.09mΩ (typical) @  $V_{GS}$ =10V  $R_{DS(ON)}$ =1.5mΩ (typical) @  $V_{GS}$ =4.5V
- Excellent gate charge x R<sub>DS(on)</sub> product(FOM)
- Very low on-resistance R<sub>DS(on)</sub>
- 150 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

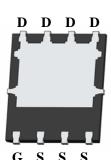
#### **Application**

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification



**Schematic Diagram** 





**Top View** 

**Bottom View** 

100% UIS TESTED!

100% ΔVds TESTED!

#### **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP40T15GU	NCEP40T15GU	DFN5X6-8L	-	-	-

#### Absolute Maximum Ratings (T<sub>C</sub>=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>	40	V	
Gate-Source Voltage	V <sub>GS</sub>	±20	V	
Drain Current-Continuous (Silicon Limited)	I <sub>D</sub>	150	А	
Drain Current-Continuous(T <sub>C</sub> =100 °C)	I <sub>D</sub> (100℃)	106	Α	
Pulsed Drain Current (Package Limited)	I <sub>DM</sub>	400	А	
Maximum Power Dissipation	P <sub>D</sub>	88	W	
Derating factor		0.7	W/℃	
Single pulse avalanche energy (Note 5)	E <sub>AS</sub>	1250	mJ	
Operating Junction and Storage Temperature Range	$T_{J}, T_{STG}$	-55 To 150	$^{\circ}$ C	



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# NCEP40T15GU

#### **Thermal Characteristic**

Electrical Characteristics (T<sub>C</sub>=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	40		-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =40V,V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	1.0	1.5	2.0	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =20A	-	1.09	1.35	mΩ
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =20A	-	1.5	1.85	mΩ
Forward Transconductance	<b>g</b> FS	V <sub>DS</sub> =5V,I <sub>D</sub> =20A		80	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C <sub>lss</sub>	.,	-	5200	-	PF
Output Capacitance	Coss	$V_{DS}$ =20V, $V_{GS}$ =0V, F=1.0MHz	-	1700	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.UIVIHZ	-	85	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t <sub>d(on)</sub>		-	12	-	nS
Turn-on Rise Time	t <sub>r</sub>	$V_{DD}$ =20V, $I_D$ =20A	-	6.5	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10V, $R_{G}$ =1.6 $\Omega$	-	49	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	8	-	nS
Total Gate Charge	Qg	V -20VI -20A	-	91	-	nC
Gate-Source Charge	$Q_{gs}$	$V_{DS}=20V, I_{D}=20A,$	-	13		nC
Gate-Drain Charge	$Q_{gd}$	V <sub>GS</sub> =10V	-	16		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =75A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	150	Α
Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25°C, I <sub>F</sub> = I <sub>S</sub>	-		30	nS
Reverse Recovery Charge	covery Charge Qrr di/dt = 100A/µs <sup>(Note3)</sup>		-		110	nC

#### Notes:

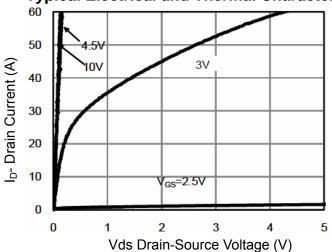
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width  $\leq$  300 $\mu$ s, Duty Cycle  $\leq$  2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25  $^{\circ}\text{C}$  ,V\_DD=20V,V\_G=10V,L=0.5mH,Rg=25 $\Omega$

**Pb Free Product** 

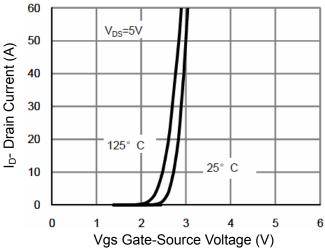


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**Figure 1 Output Characteristics** 



**Figure 2 Transfer Characteristics** 

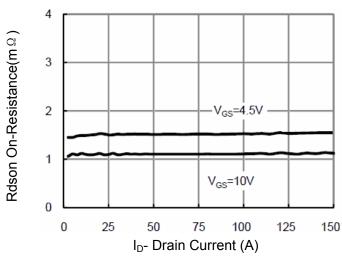


Figure 3 Rdson- Drain Current

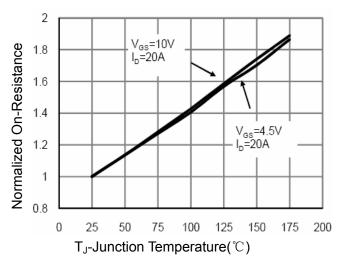


Figure 4 Rdson-JunctionTemperature

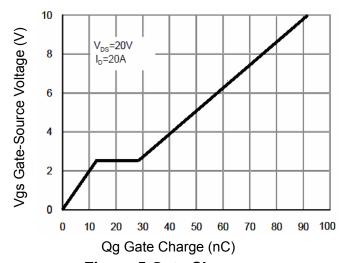


Figure 5 Gate Charge

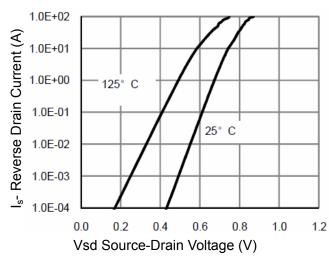
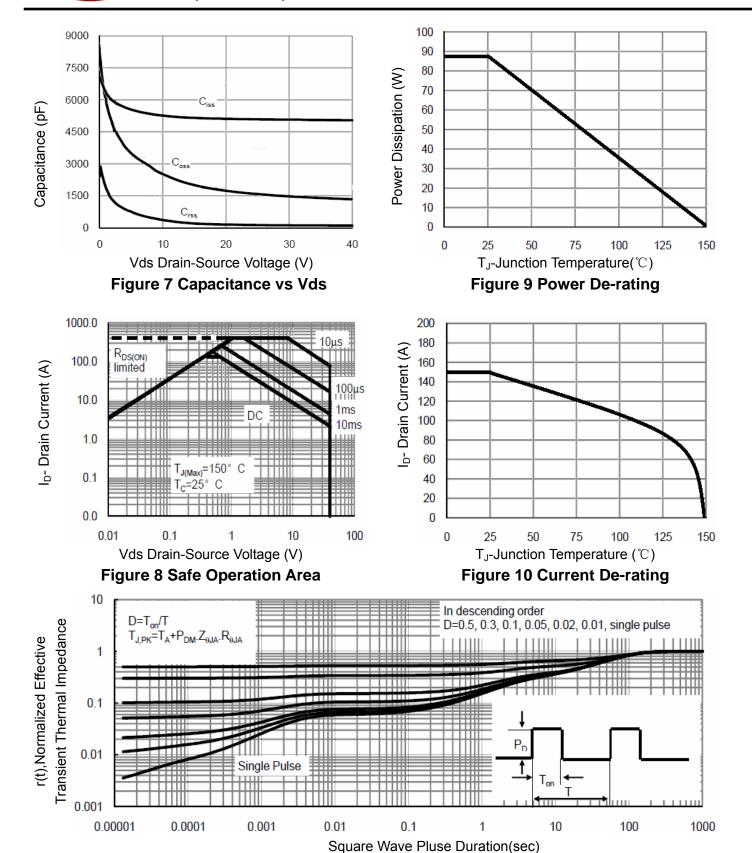


Figure 6 Source- Drain Diode Forward

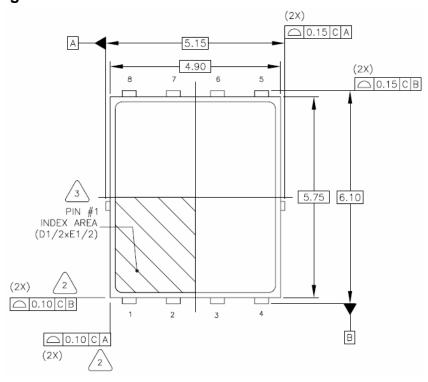


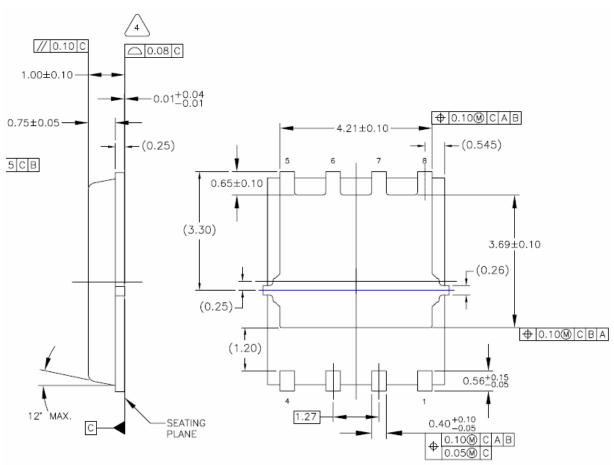
**Figure 11 Normalized Maximum Transient Thermal Impedance** 

**Pb Free Product** 



## **DFN5X6-8L Package Information**







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# NCEP40T15GU

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